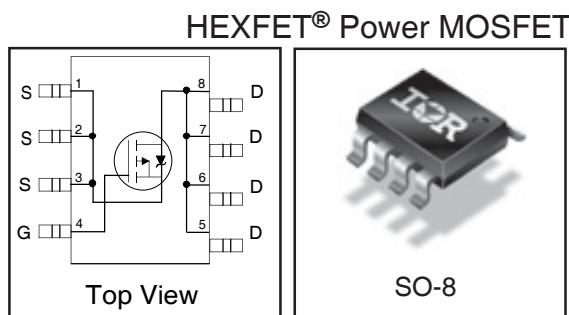


<b>V<sub>DS</sub></b>	<b>-12</b>	<b>V</b>
<b>R<sub>DS(on)</sub> max</b> (@V <sub>GS</sub> = -4.5V)	<b>7</b>	<b>mΩ</b>
<b>R<sub>DS(on)</sub> max</b> (@V <sub>GS</sub> = -2.5V)	<b>9</b>	
<b>R<sub>DS(on)</sub> max</b> (@V <sub>GS</sub> = -1.8V)	<b>13</b>	
<b>Q<sub>g</sub> (typical)</b>	<b>91</b>	<b>nC</b>
<b>I<sub>D</sub></b> (@T <sub>A</sub> = 25°C)	<b>-16</b>	<b>A</b>



#### Features

Industry-standard pinout SO-8 Package
Compatible with Existing Surface Mount Techniques
RoHS Compliant, Halogen-Free
MSL1, Industrial qualification

#### Benefits

Multi-Vendor Compatibility
Easier Manufacturing
Environmentally Friendlier
Increased Reliability

Base Part Number	Package Type	Standard Pack		Orderable Part Number
		Form	Quantity	
IRF7410PbF-1	SO-8	Tape and Reel	4000	IRF7410TRPbF-1

#### Absolute Maximum Ratings

	Parameter	Max.	Units
V <sub>DS</sub>	Drain- Source Voltage	-12	V
I <sub>D</sub> @ T <sub>A</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ -4.5V	-16	
I <sub>D</sub> @ T <sub>A</sub> = 70°C	Continuous Drain Current, V <sub>GS</sub> @ -4.5V	-13	A
I <sub>DM</sub>	Pulsed Drain Current ①	-65	
P <sub>D</sub> @ T <sub>A</sub> = 25°C	Power Dissipation ③	2.5	
P <sub>D</sub> @ T <sub>A</sub> = 70°C	Power Dissipation ③	1.6	W
	Linear Derating Factor	20	mW/°C
V <sub>GS</sub>	Gate-to-Source Voltage	±8	V
T <sub>J</sub> , T <sub>STG</sub>	Junction and Storage Temperature Range	-55 to +150	°C

#### Thermal Resistance

	Parameter	Max.	Units
R <sub>θJA</sub>	Maximum Junction-to-Ambient③	50	°C/W

**Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

Symbol	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	-12	—	—	V	$V_{GS} = 0V, I_D = -250\mu\text{A}$
$\Delta V_{(\text{BR})\text{DSS}/\Delta T_J}$	Breakdown Voltage Temp. Coefficient	—	0.006	—	V/ $^\circ\text{C}$	Reference to $25^\circ\text{C}, I_D = -1\text{mA}$
$R_{DS(\text{on})}$	Static Drain-to-Source On-Resistance	—	—	7	$\text{m}\Omega$	$V_{GS} = -4.5V, I_D = -16\text{A}$ ②
		—	—	9		$V_{GS} = -2.5V, I_D = -13.6\text{A}$ ②
		—	—	13		$V_{GS} = -1.8V, I_D = -11.5\text{A}$ ②
$V_{GS(\text{th})}$	Gate Threshold Voltage	-0.4	—	-0.9	V	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$
$\Delta V_{GS(\text{th})/\Delta T_J}$	Gate Threshold Voltage Coefficient	—	-3.09	—	$\text{mV}/^\circ\text{C}$	
$g_{fs}$	Forward Transconductance	55	—	—	S	$V_{DS} = -10V, I_D = -16\text{A}$
$I_{DSS}$	Drain-to-Source Leakage Current	—	—	-1.0	$\mu\text{A}$	$V_{DS} = -9.6V, V_{GS} = 0V$
		—	—	-25		$V_{DS} = -9.6V, V_{GS} = 0V, T_J = 70^\circ\text{C}$
$I_{GSS}$	Gate-to-Source Forward Leakage	—	—	-100	$\text{nA}$	$V_{GS} = -8V$
	Gate-to-Source Reverse Leakage	—	—	100		$V_{GS} = 8V$
$Q_g$	Total Gate Charge	—	91	—	$\text{nC}$	$I_D = -16\text{A}$
$Q_{gs}$	Gate-to-Source Charge	—	18	—		$V_{DS} = -9.6V$
$Q_{gd}$	Gate-to-Drain ("Miller") Charge	—	25	—		$V_{GS} = -4.5V$ ②
$t_{d(on)}$	Turn-On Delay Time	—	13	20	$\text{ns}$	$V_{DD} = -6V \quad V_{GS} = -4.5V$
$t_r$	Rise Time	—	12	18		$I_D = -1.0\text{A}$
$t_{d(off)}$	Turn-Off Delay Time	—	271	407		$R_D = 6\Omega$
$t_f$	Fall Time	—	200	300		$R_G = 6\Omega$ ②
$C_{iss}$	Input Capacitance	—	8676	—	$\text{pF}$	$V_{GS} = 0V$
$C_{oss}$	Output Capacitance	—	2344	—		$V_{DS} = -10V$
$C_{rss}$	Reverse Transfer Capacitance	—	1604	—		$f = 1.0 \text{ MHz}$

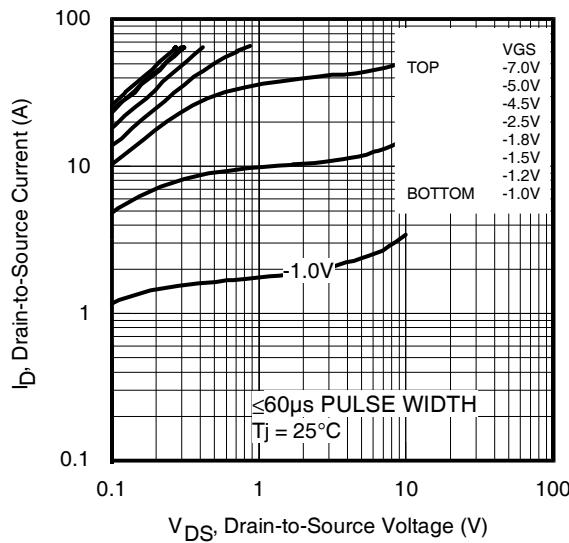
**Source-Drain Ratings and Characteristics**

Symbol	Parameter	Min.	Typ.	Max.	Units	Conditions
$I_S$	Continuous Source Current (Body Diode)	—	—	-2.5	A	MOSFET symbol showing the integral reverse p-n junction diode.
$I_{SM}$	Pulsed Source Current (Body Diode) ①	—	—	-65		
$V_{SD}$	Diode Forward Voltage	—	—	-1.2		$T_J = 25^\circ\text{C}, I_S = -2.5\text{A}, V_{GS} = 0V$ ②
$t_{rr}$	Reverse Recovery Time	—	97	145	ns	$T_J = 25^\circ\text{C} \quad I_F = -2.5\text{A}$
$Q_{rr}$	Reverse Recovery Charge	—	134	201	$\mu\text{C}$	$dI/dt = -100\text{A}/\mu\text{s}$ ②

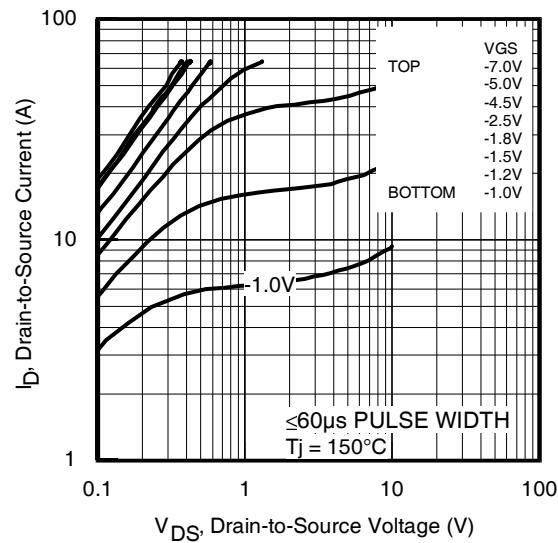
**Notes:**

- ① Repetitive rating; pulse width limited by max. junction temperature.  
 ② Pulse width  $\leq 400\mu\text{s}$ ; duty cycle  $\leq 2\%$ .

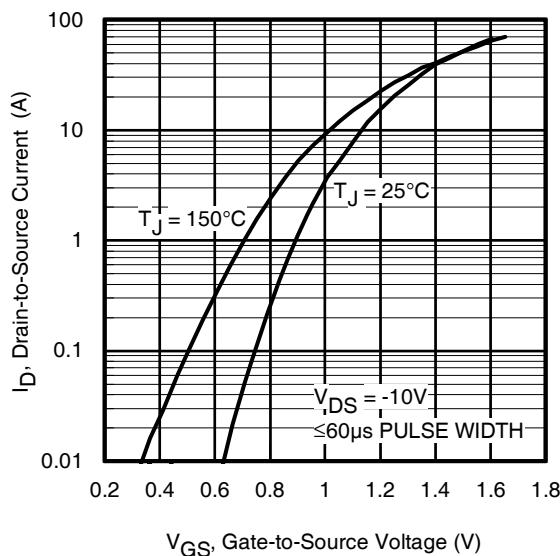
③ Surface mounted on 1 in square Cu board,  $t \leq 10\text{sec}$ .



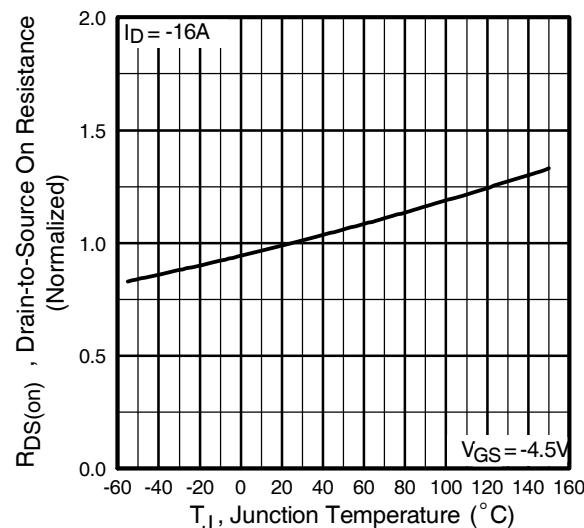
**Fig 1.** Typical Output Characteristics



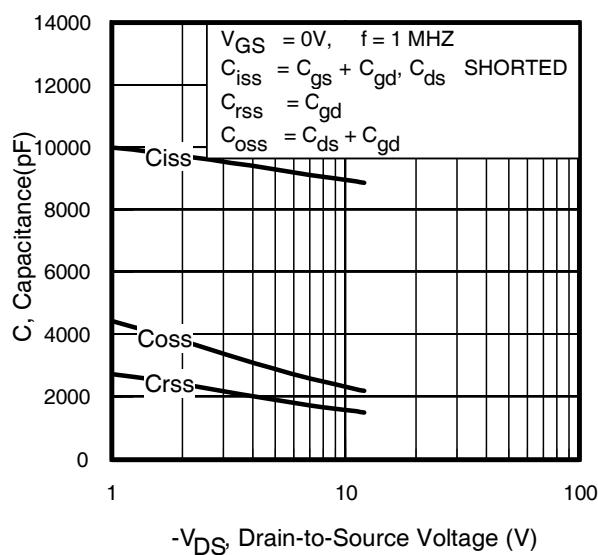
**Fig 2.** Typical Output Characteristics



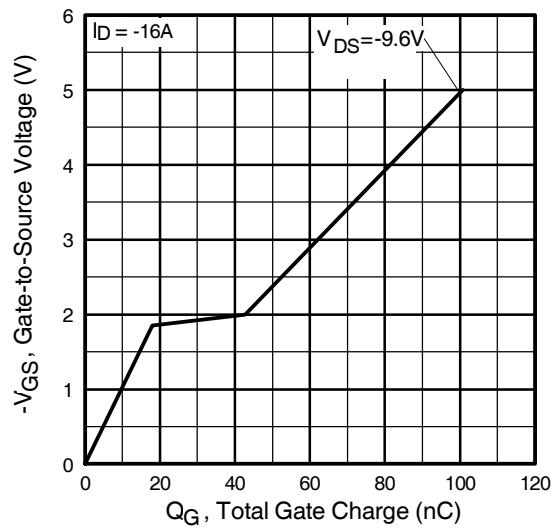
**Fig 3.** Typical Transfer Characteristics



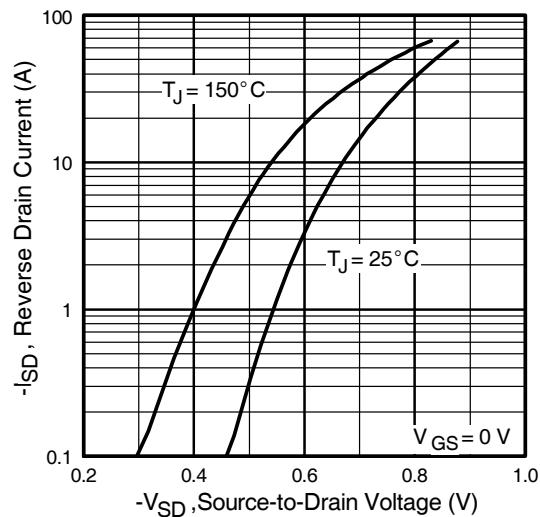
**Fig 4.** Normalized On-Resistance Vs. Temperature



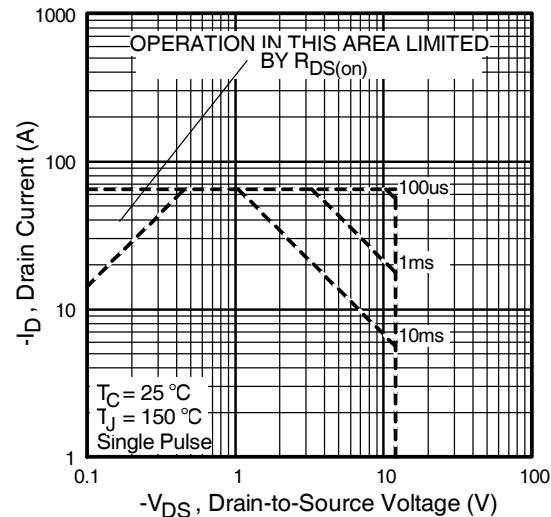
**Fig 5.** Typical Capacitance Vs.  
Drain-to-Source Voltage



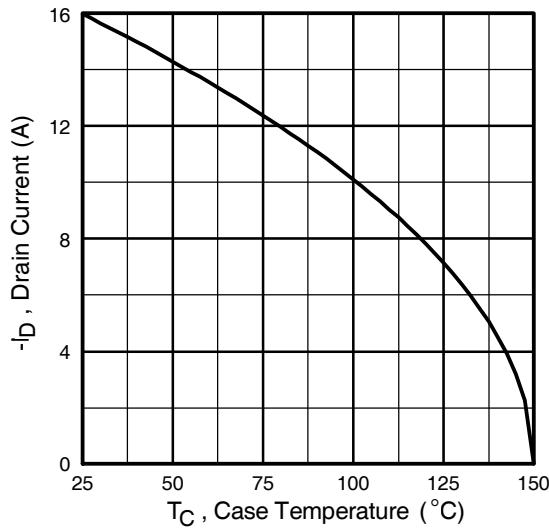
**Fig 6.** Typical Gate Charge Vs.  
Gate-to-Source Voltage



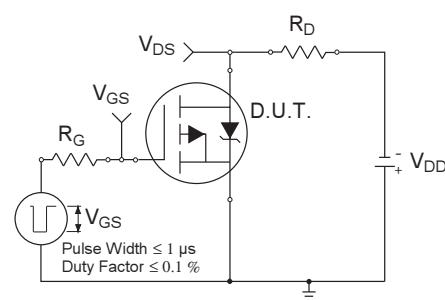
**Fig 7.** Typical Source-Drain Diode  
Forward Voltage



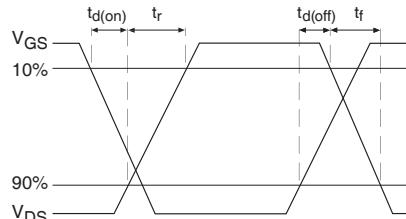
**Fig 8.** Maximum Safe Operating Area



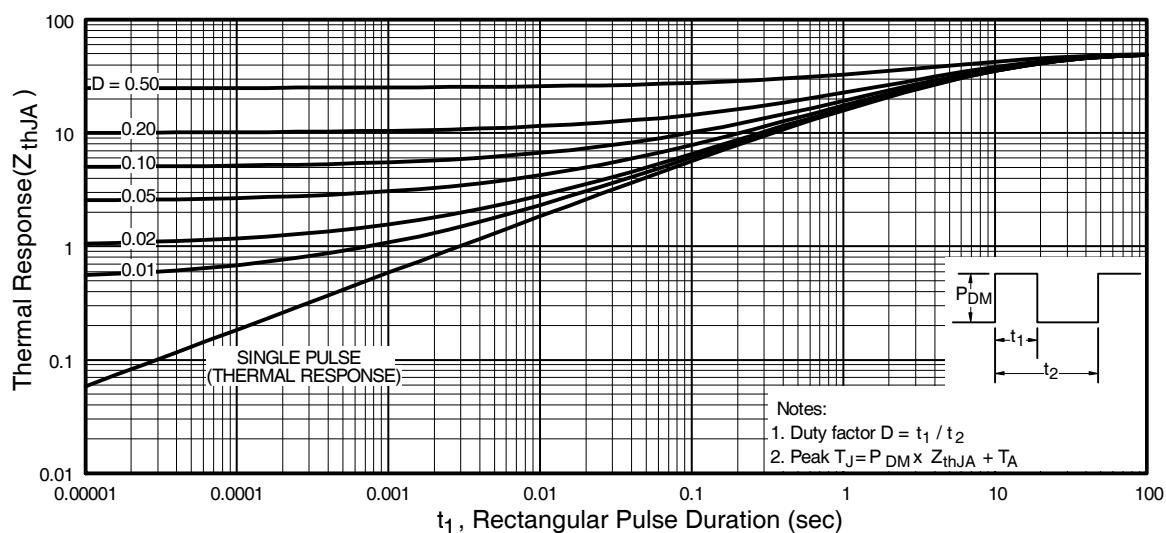
**Fig 9.** Maximum Drain Current Vs.  
Case Temperature



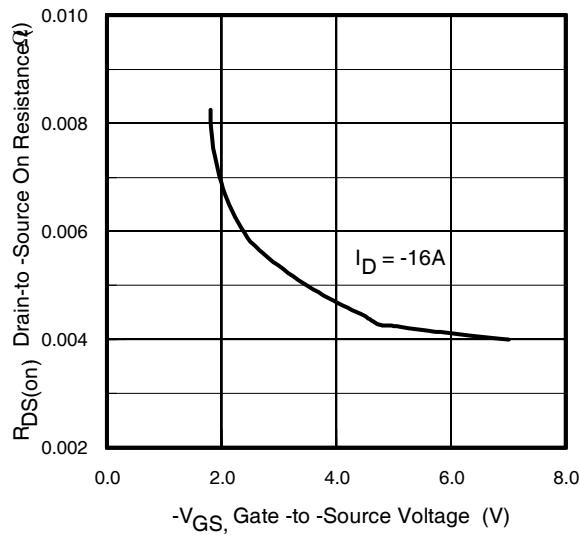
**Fig 10a.** Switching Time Test Circuit



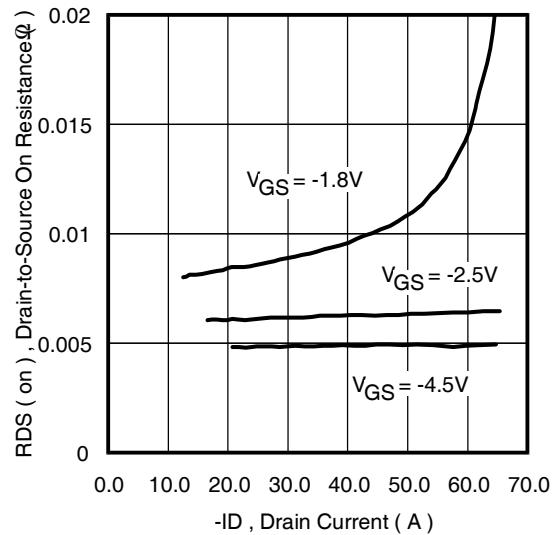
**Fig 10b.** Switching Time Waveforms



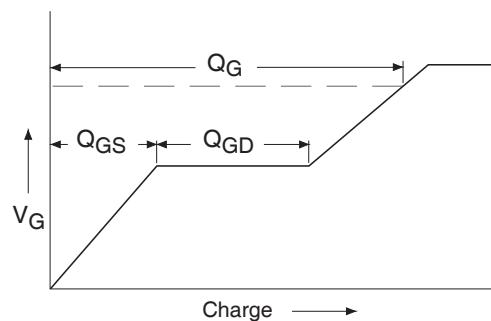
**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



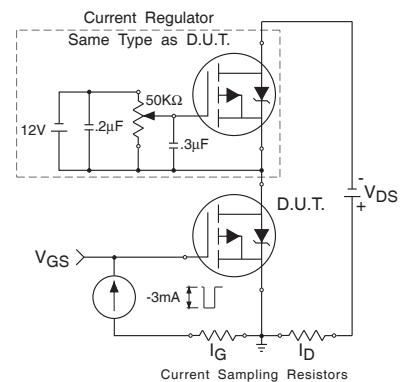
**Fig 12.** Typical On-Resistance Vs.  
Gate Voltage



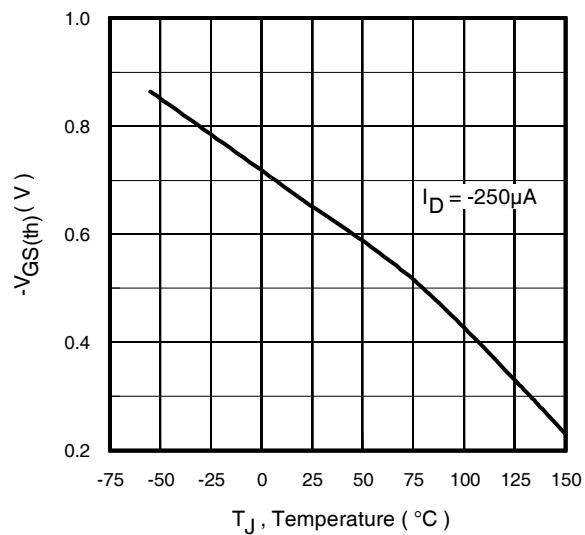
**Fig 13.** Typical On-Resistance Vs.  
Drain Current



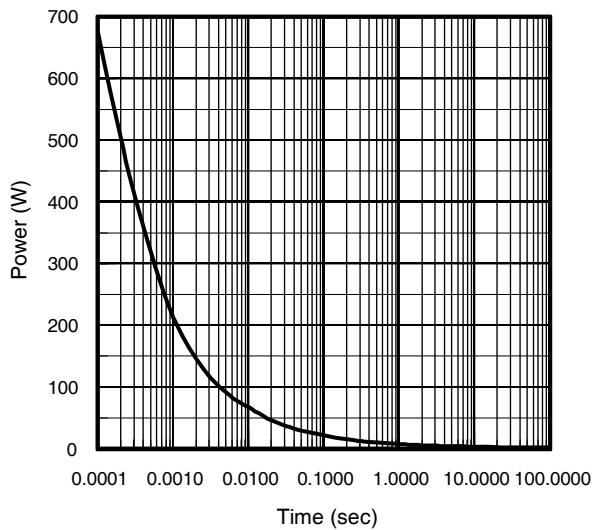
**Fig 14a.** Basic Gate Charge Waveform



**Fig 14b.** Gate Charge Test Circuit



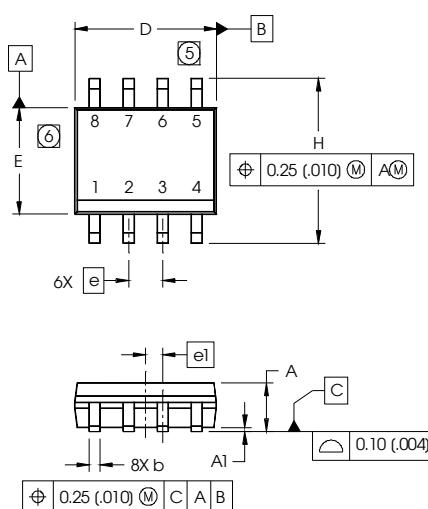
**Fig 15.** Typical  $V_{GS(th)}$  Vs.  
Junction Temperature



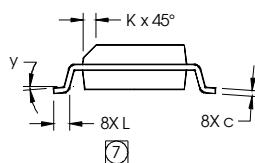
**Fig 16.** Typical Power Vs. Time

## SO-8 Package Outline (Mosfet & Fetky)

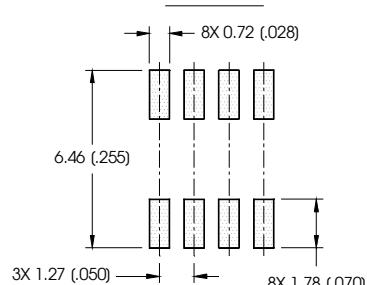
Dimensions are shown in millimeters (inches)



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.0532	.0688	1.35	1.75
A1	.0040	.0098	0.10	0.25
b	.013	.020	0.33	0.51
c	.0075	.0098	0.19	0.25
D	.189	.1968	4.80	5.00
E	.1497	.1574	3.80	4.00
e	.050	BASIC	1.27	BASIC
e1	.025	BASIC	0.635	BASIC
H	.2284	.2440	5.80	6.20
K	.0099	.0196	0.25	0.50
L	.016	.050	0.40	1.27
y	0°	8°	0°	8°

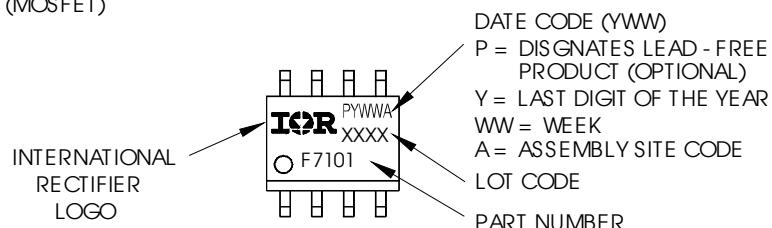


FOOTPRINT

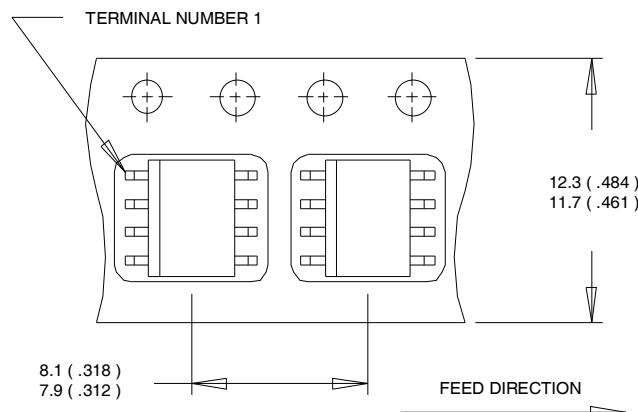


## SO-8 Part Marking Information

EXAMPLE: THIS IS AN IRF7101 (MOSFET)

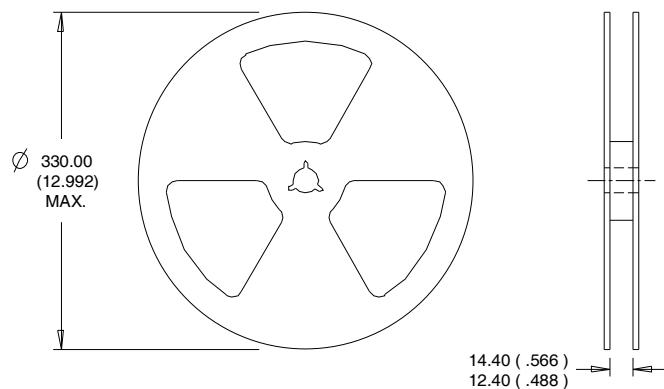


Note: For the most current drawing please refer to IR website at: <http://www.irf.com/package/>

**SO-8 Tape and Reel** (Dimensions are shown in millimeters (inches))

## NOTES:

1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



## NOTES :

1. CONTROLLING DIMENSION : MILLIMETER.
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Note: For the most current drawing please refer to IR website at: <http://www.irf.com/package/>



IRF7410TRPbF-1

**Qualification information<sup>†</sup>**

Qualification level	Industrial (per JEDEC JESD47F <sup>††</sup> guidelines)	
Moisture Sensitivity Level	SO-8	MSL1 (per JEDEC J-STD-020D <sup>††</sup> )
RoHS compliant	Yes	

<sup>†</sup> Qualification standards can be found at International Rectifier's web site: <http://www.irf.com/product-info/reliability>

<sup>††</sup> Applicable version of JEDEC standard at the time of product release

**Revision History**

Date	Comments
10/16/2014	<ul style="list-style-type: none"><li>• Corrected part number from "IRF7410PbF-1" to "IRF7410TRPbF-1" -all pages</li><li>• Removed the "IRF7410PbF-1" bulk part number from ordering information on page1</li></ul>

International  
**IR** Rectifier

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To contact International Rectifier, please visit <http://www.irf.com/photo-call/>